

U.S. DEPARTMENT OF COMMERCE

(Rev. 03/01) OMB No. 0651-0027 (exp. 5/31/2002)	10256894	7	U.S. Patent and Trademark Office
To the Honorable Commissioner of Patents at	nd Trademarks: Plea	se record the attached origina	al documents or copy thereof
Name of conveying party(ies):	2	. Name and address of re	ceiving party(ies)
Mitsuru Asano (09/11/2003) and Akira Yumoto (09/11/2003)		Name: Sony Corporation	
		Internal Address:	
Additional name(s) of conveying party(ies) attached?	res x No	Street Address: 6-7-35 Kitashinagawa Shinagawa-Ku	
Nature of Conveyance: X Assignment Merger	r		9-23-03
	e of Name	City: Tokyo	
Other		Country: Japan Zip: 141-0001	
Execution Date: see Box 1, conveying parties		Additional name(s) & address(es) attached:	Yes x No
4. Application number(s) or patent number	er(s):		
If this document is being filed together with a new A. Patent Application No.(s):		ution date of the new application . Patent No.(s):	n is: 1 & 2 - 9/11/03
	numbers attached	<u></u>	
5. Name and address of party to whom correspondence concerning document should be mailed:		. Total number of applicating patents involved:	ons and1
Name: Ronald P. Kananen RADER, FISHMAN & GRAUER PLLC		. Total fee (37 CFR 3.41)	\$40.00
Street Address: 1233 20th Street, N.W. Suite 501		 	charged to deposit account charged to credit card
	8	. Deposit account number	
City: State: Zip	: [•	-0013
Washington DC 200	036	(Attach duplicate copy of this pa	age if paying by deposit account)
	DO NOT USE TH	IS SPACE	
9. Statement and signature.	Λ		
To the best of my knowledge and belief, the is a true copy of the original document.	ne foregoing inførd	nation is true and correct a	nd any attached copy
Ronald P. Kananen, Reg. No. 24,104			September 23, 2003
Name of Person Signing	<i>\(\)</i>	Signature	Date
Total number of pages including	cover sheet, attachme	ents, and do cuments: 3	
00000126, 180013 10667596 40,00 DQ	/		

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PATENT REEL: 014551 FRAME: 0107

Docket	Number:	SON-2827
	* 4111 OCL .	

ASSIGNMENT WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in ACTIVE-MATRIX DISPLAY DEVICE AND METHOD OF DRIVING THE SAME for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address: AND WHEREAS, Sony Corporation, a Japanese corporation with offices at 7-35 Kitashinagawa 6-Chome. Shinagawa-Ku, Tokyo, Japan (hereinafter referenced as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries; NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto; And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto; And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense; And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto; And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale. And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: Serial Number: ______, Filing Date:______. This assignment executed on the dates indicated below. Mitsuru ASANO Name of first or sole inventor Execution date of U.S. Patent Application Kanagawa, Japan Residence of first or sole inventor September 11, 2003

Bate of this assignment

mitsuru asano

PATENT REEL: 014551 FRAME: 0108

Akira YUMOTO Name of second inventor Execution date of U.S. Patent Application Kanagawa, Japan Residence of second inventor Signature of second inventor Execution date of U.S. Patent Application Name of third inventor Residence of third inventor Date of this assignment Signature of third inventor Execution date of U.S. Patent Application Name of fourth inventor Residence of fourth inventor Date of this assignment Signature of fourth inventor Execution date of U.S. Patent Application Name of fifth inventor Residence of fifth inventor Date of this assignment Signature of fifth inventor

RECORDED: 09/23/2003

PATENT REEL: 014551 FRAME: 0109